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	Class	Subclass

**ISSUE CLASSIFICATION**

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**U.S. UTILITY Patent Application**

O.I.P.E.	PATENT DATE
TR SCANNED <i>11/2</i> Q.A. <i>A.G.</i>	

PATENT NUMBER

APPLICATION NO. 09/696117	CONT/PRIOR F	CLASS <u>428</u> <u>235</u>	SUBCLASS <u>494</u>	PART UNIT <u>2812</u>	EXAMINER <u>J. F. KELLY</u>
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## APPlicants

Gakushū Kitagawa

title

## Marking method for semiconductor wafer

PTO-2040  
12/99

### The information

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